

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: N. FUKUTOMI, et al.
Appln. No. 10/042,408
Filed: JANUARY 8, 2002
For: FABRICATION PROCESS OF SEMICONDUCTOR PACKAGE
AND SEMICONDUCTOR PACKAGE
Group AU: 2813
Examiner: Nema O. Berezny
Confirm. No: 9036

SUBMISSION UNDER 37 CFR 1.114 (AMENDMENT)**Mail Stop: RCE**

Commissioner for Patent
P.O. Box 1450
Alexandria, VA 22313-1450

January 17, 2006

Sir:

In response to the Office Action mailed May 17, 2005, and concurrently with the filing of a Request for Continued Examination (RCE) Transmittal, please amend the above-identified application as listed in the following, and as set forth on the following pages:

AMENDMENTS TO THE CLAIMS; and

REMARKS are included following the amendments.